

Specification for Approval

Customer:	
Customer.	

Model Name:

Si	upplier Approv	Customer approval	
R&D Designed	R&D Approved	QC Approved	
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RECORD OF REVISION

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1.0 General Description

1.1 Application

● 绘图板

1.2 General Specification

1.2.1.General FOB Specification(Table 1.)

<table 1.="" general="" specifications=""></table>
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Parameter	Specification	Unit	Remarks
Active area	293.76 (H) x 165.24 (V)	mm	
Number of pixels	1920 (H) x 1080 (V)	pixels	
Pixel pitch	0.153 (H) x 0.153 (V)	mm	
Pixel arrangement	RGB Vertical stripe		
Display colors	16.7M	colors	
Display mode	Normally Black		
Dimensional outline	305.2(H)*187.9(V) *2.6(D)	mm	
Weight	-	g	
Back-light	Lower Down side, 1-LED Lighting Bar type		Note 1
	-	W	
Power consumption	-	W	
	-	W	



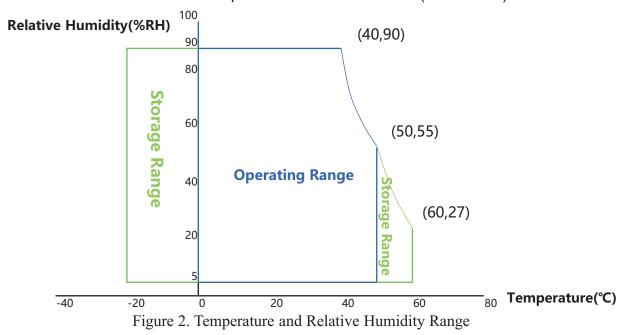
2.0 ABSOLUTE MAXIMUM RATINGS

The followings are maximum values which, if exceed, may cause faulty operation or damage to the unit. The operational and non-operational maximum voltage and current values are listed in Table 2.

	Ta=25+/-2°C					
Parameter	Symbol	Min.	Max.	Unit	Remarks	
Power Supply Voltage	LCD_VCC	-0.3	5	V	Note 1	
BLU Power Supply Voltage	BL_PWR	-0.3	27	V	Note 1	
Operating Temperature	T _{OP}	0	+50	°C	Note 2	
Storage Temperature	T _{ST}	-20	+60	°C	Note 2	

Notes : 1. Permanent damage to the device may occur if maximum values are exceeded functional operation should be restricted to the condition described under normal operating conditions.

Temperature and relative humidity range are shown in the figure below.
90 % RH Max. (40 °C ≥ Ta)
Maximum wet - bulb temperature at 39 °C or less. (Ta > 40 °C) No condensation.





Ta=25+/-2°C

3.0 ELECTRICAL SPECIFICATIONS

3.1 Electrical Specifications

Parameter	Symbol		Values		Unit	Notes
raiameter	Cymbol	Min	Тур	Max	Unit	
Power Supply Input Voltage	LCD_VCC	3.0	3.3	3.6	V	Note 1
Power Supply Current	I _{LCD_VCC}	-	-	-	mA	NOLE 1
In-Rush Current	I _{RUSH}	-	-	-	А	
Permissible Input Ripple Voltage	V _{RF}	-	-	-	mV	

< Table 3. Electrical specifications >

Notes : 1. The supply voltage is measured and specified at the interface connector of FOB. The current draw and power consumption specified is for 3.3V at 25 °C



Ta=25+/-2°C

3.2 Back-light Unit

< Table 3.2 LED Driving guideline specifications >

Parameter		_	Min.	Тур.	Max.	Unit	Remarks
Power supply LED Driver	y voltage for	BL_P WR	5	12	21	V	
Power supply Back light	y Current for	V _{BLU}	-	21	-	V	
Power supply Back light	y Current for	I _{BLU}	-	160	-	mA	背光灯串: 8并7 串
Power supply for Back light		P _{BL_PWR}	-	3.95	-	W	LED Power Consu mption follow cust omerrequirements
EN Control	Backlight on	V _{ENH}	1.6	-	BL_P WR	V	EN logic high v oltage
Level	Backlight off	V _{ENL}	0	-	0.8	V	EN logic low vol tage
PWM Control	PWM High Level	V _{PML}	1.6	-	BL_P WR	V	
Level	PWM Low Level	V _{PML}	0	-	0.8	V	
PWM Contro	I Frequency	F _{PWM}	0.2	-	20	KHz	
Duty Ratio		-	25	-	100	%	

Notes : 1. Calculator Value for reference $I_{BLU} \times V_{BLU} = P_{BL_PWR}*85\%$

2. The LED Life-time define as the estimated time to 50% degradation of initial luminous under the condition of the ambient temperature of 25°C.



4.0 OPTICAL SPECIFICATION

4.1 Overview

The test of Optical specifications shall be measured in a dark room (ambient luminance ≤ 1 lux and temperature = $25\pm2^{\circ}$ C) with the equipment of Luminance meter system (Goniometer system and TOPCON BM-5) and test unit shall be located at an approximate distance 50cm from the LCD surface at a viewing angle of θ and Φ equal to 0°. We refer to $\theta \emptyset$ =0 (= θ 3) as the 3 o'clock direction (the "right"), $\theta \emptyset$ =90 (= θ 12) as the 12 o'clock direction ("upward"), $\theta \emptyset$ =180 (= θ 9) as the 9 o'clock direction ("left") and $\theta \emptyset$ =270(= θ 6) as the 6 o'clock direction ("bottom"). While scanning θ and/or \emptyset , the center of the measuring spot on the Display surface shall stay fixed. The backlight should be operating for 30 minutes prior to measurement. VDD shall be 3.3+/- 0.3V at 25°C. Optimum viewing angle direction is 6 'clock.

4.2 Optical Specifications

Parameter		Symbol	Condition	Min.	Тур.	Max.	Unit	Remark
	Horizontal	Θ ₃		-	85	-	Deg.	
Viewing Angle	HUHZUHLAI	Θ ₉	CR > 10	-	85	-	Deg.	Note 1
range	Vertical	Θ ₁₂		-	85	-	Deg.	NOLE I
	Ventical	Θ_6		-	85	-	Deg.	
Luminance Co	ntrast ratio	CR	Θ = 0°	800	1000	-	-	
Luminance of White	5 Points	Y _w	Θ = 0°	200	-	-	cd/m^2	
White	5 Points	ΔY5	$I_{LED} = 23.5 mA$	80	-	-	-	T
Luminance uniformity	9 Points	ΔΥ9		75	-	-	-	Туре.
White Chro	moticity	X _w	$\Theta = 0^{\circ}$	0.283	0.313	0.343	-	
white Child	maticity	У _w	0 = 0	0.293	0.329	0.359	-	
	Red	X _R			0.653		-	
	- Tieu	У _R			0.341		-	
Reproduction	Green	X _G	Θ = 0°	-0.03	0.322	+0.03	-	
of color		У _G	0-0	-0.05	0.618	10.05	-	
	Blue	X _B			0.149		-	
	Dide	У _В			0.066		-	
Gamı	ut	-	-	68	72	-	%	
Response (Rising + F		T _{RT}	Ta= 25° C Θ = 0°	-	30	35	Ms	Note 6
Cross T	alk	CT	Θ = 0°	-	-	-	%	

<Table 5. Optical Specifications>



Notes :

1. Viewing angle is the angle at which the contrast ratio is greater than 10. The viewing angles are determined for the horizontal or 3, 9 o'clock direction and the vertical or 6, 12 o'clock direction with respect to the optical axis which is normal to the LCD surface (see FIGURE 1).

2. Contrast measurements shall be made at viewing angle of Θ = 0 and at the center of the LCD surface. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black) state.

(see FIGURE 1) Luminance Contrast Ratio (CR) is defined mathematically.

3. Center Luminance of white is defined as luminance values of 5 point average across the LCD surface. Luminance shall be measured with all pixels in the view field set first to white. This measurement shall be taken at the locations shown in FIGURE 2 for a total of the measurements per display.

4. The White luminance uniformity on LCD surface is then expressed as : ΔY =Minimum Luminance of 5(or 13) points / Maximum Luminance of 5(or 13) points. (see FIGURE 2 and FIGURE 3).

5. The color chromaticity coordinates specified in Table 5 shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the panel.

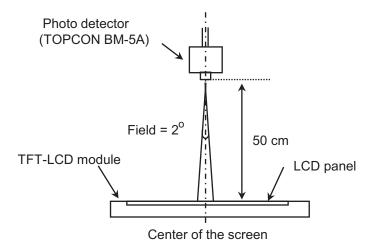
6. The electro-optical response time measurements shall be made as FIGURE 4 by switching the "data" input signal ON and OFF. The times needed for the luminance to change from 10% to 90% is Tr, and 90% to 10% is Td.

7. Cross-Talk of one area of the LCD surface by another shall be measured by comparing the luminance (YA) of a 25mm diameter area, with all display pixels set to a gray level, to the luminance (YB) of that same area when any adjacent area is driven dark. (See FIGURE 5).



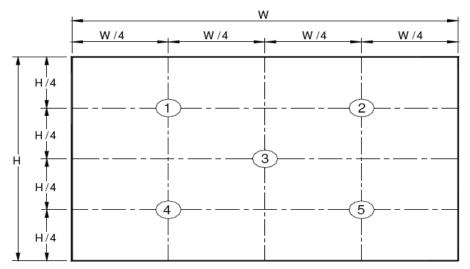
4.3 Optical measurements





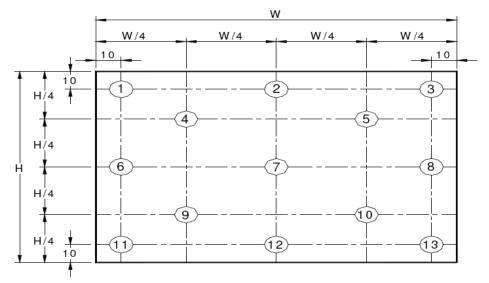
Optical characteristics measurement setup



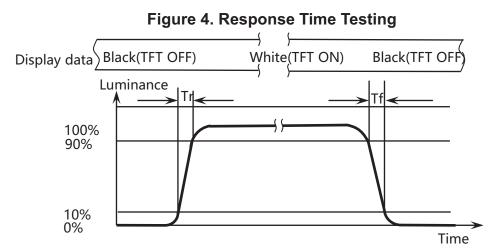


Center Luminance of white is defined as luminance values of center 5 points across the LCD surface. Luminance shall be measured with all pixels in the view field set first to white. This measurement shall be taken at the locations shown in FIGURE 2 for a total of the measurements per display.

Figure 3. Uniformity Measurement Locations (13 points)



The White luminance uniformity on LCD surface is then expressed as : Δ Y5 = Minimum Luminance of five points / Maximum Luminance of five points (see FIGURE 2), Δ Y13 = Minimum Luminance of 13 points /Maximum Luminance of 13 points (see FIGURE 3).



The electro-optical response time measurements shall be made as shown in FIGURE 4 by switching the "data" input signal ON and OFF. The times needed for the luminance to change from 10% to 90% is Tr and 90% to 10% is Tf.

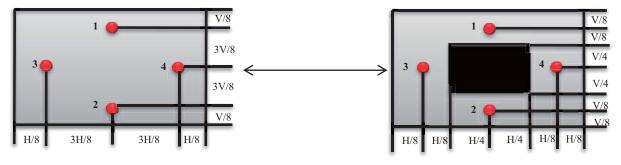


Figure 5. Cross Talk Modulation Test Description

Cross-Talk (%) =
$$\left| \frac{Y_B - Y_A}{Y_A} \right| \times 100$$

Where:

 $Y_A =$ Initial luminance of measured area (cd/m²)

 $Y_B =$ Subsequent luminance of measured area (cd/m²)

The location 1/2/3/4 measured will be exactly the same in both patterns. The test background gray is from L64 to L192. Take the largest data as the result.

Cross Talk of one area of the LCD surface by another shall be measured by comparing the luminance (YA) of a 25mm diameter area, with all display pixels set to a gray level, to the luminance (YB) of that same area when any adjacent area is driven dark.(Refer to Figure 5) The test system: PR730



5.0 INTERFACE CONNECTION.

5.1 TFT Electrical Interface Connection

The electronics interface connector is MSAK24025P30. The connector interface pin assignments are listed in Table 6.

<Table 6. Pin Assignments for the Interface Connector>

Terminal	Symbol	Functions			
Pin No.	Symbol	Description			
1	NC	Non Connection			
2	H-GND	Ground			
3	LAN1_N	Complement Signal Link_Lane1			
4	LAN1_P	True Signal Link_Lane1			
5	H-GND	Ground			
6	LAN0_N	Complement Signal Link_Lane0			
7	LAN0_P	True Signal Link_Lane0			
8	H-GND	Ground			
9	AUXP	True Signal Link_Auxiliry Channel			
10	AUXN	Complement Signal Link_Auxiliry Channel			
11	H-GND	Ground			
12	LCD_VCC	Power Supply, 3.3V (typ.)			
13	LCD_VCC	Power Supply, 3.3V (typ.)			
14	BIST	Panel self test enable			
15	H-GND	Ground			
16	H-GND	Ground			
17	HPD	HPD(Hot Plug Detect) Signal Pin			
18	BL_GND	High Speed Ground			
19	BL_GND	High Speed Ground			
20	BL_GND	High Speed Ground			
21	BL_GND	High Speed Ground			
22	BL_EN	Backlight on/off Control pin			
23	BL_PWM	Back light PWM Dimming			
24	NC	Non Connection			
25	NC	Non Connection			
26	BL_PWR	Backlight power			
27	BL_PWR	Backlight power			
28	BL_PWR	Backlight power			
29	BL_PWR	Backlight power			
30	NC	Non Connection			



5.2 CTP Electrical Interface Connection

PIN NO.	PIN NAME	Description			
1	VDD	CTP Digital Power.			
2	RST	CTP reset pin. Active low to enter reset state.			
3	INT	CTP interruption signal.			
4	SDA	CTP I ² C_data			
5	SCL	CTP I ² C_clock			
6	GND	CTP Power ground			

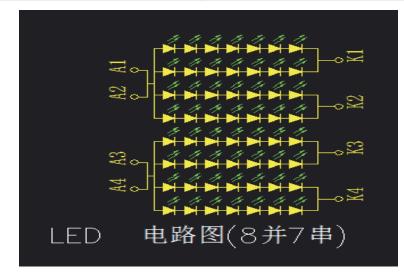


5.3 Back-light & LED Interface Connection

The electronics interface connector is 20599-015E-01

<Table 7. Pin Assignments for the BLU & FOB Connector>

Pin No.	Symbol
1	A1
2	A2
3	A3
4	A4
5	NC
6	NC
7	NC
8	K1
9	K1
10	K2
11	K2
12	K3
13	K3
14	K4
15	K4



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6.0 SIGNAL TIMING SPECIFICATION

6.1 The NV133FHM-N41 is operated by the DE only.

Item		Symbols	Min	Тур	Max	Unit
PClock	PClock Frequency		-	147.8	-	MHz
	1		-	1120	-	lines
Frame Period		Tv	-	60	-	Hz
			-	16.67	-	ms
Vertical Display Period		Tvd	-	1080	-	lines
One line Scanning Period		Th	-	2200	-	clocks
Horizonta	l Display Period	Thd	-	1920	-	clocks

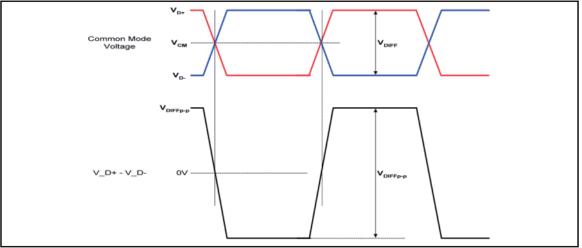


6.2 eDP Rx Interface Timing Parameter

The specification of the eDP Rx interface timing parameter is shown in Table 8.

Item	Symbol	Min	Тур	Max	Unit	Remark
Spread spectrum clock	SSC	0	-	0.5	%	
Differential peak-to-peak input volt age at package pins	VRX-DIFFp-p	120	-	1200	mV	
Rx input DC common mode voltage	VRX_DC_CM	0	-	2.0	V	
Differential termination resistance	RRX-DIFF	-	100	-	Ω	
Single-ended termination resistance	Rrx-se	-	-	-	Ω	
Rx short circuit current limit	IRX_SHORT	0	-	50	mA	

<Table 9. eDP Rx Interface Timing Specification>

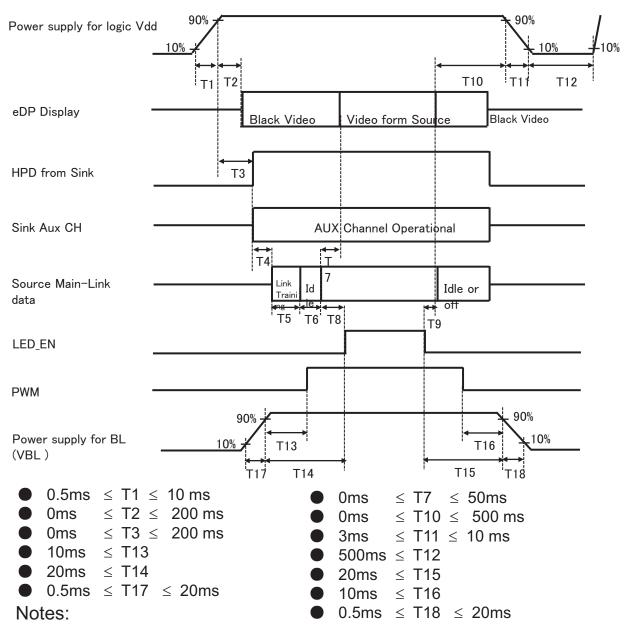


Definition of Differential Voltage and Differential Voltage Peak-to Peak



7.0 POWER SEQUENCE

To prevent a latch-up or DC operation of the LCD module, the power on/off seq uence shall be as shown in below



1. When the power supply VDD is 0V, keep the level of input signals on the low or k eep high impedance.

2. Do not keep the interface signal high impedance when power is on. Back Light must be turn on after power for logic and interface signal are valid.



8.0 RELIABILITY TEST

The Reliability test items and its conditions are shown in below.

No	Test Items	Conditions	Remark
1	High temperature storage test	$Ta = 60^{\circ}C$, 60%RH, 96 hrs	
2	Low temperature storage test	$Ta = -20^{\circ}C$, 96 hrs	
3	High temperature & high humidity operation test	Ta = 50°C , 80%RH, 96 hrs	
4	High temperature operation test	$Ta = 50^{\circ}C$, 60%RH, 96 hrs	
5	Low temperature operation test	$Ta = 0^{\circ}C$, 240 hrs	
6	Thermal shock	Ta = -20 °C \leftrightarrow 60 °C (0.5 hr), 60% ± 3%RH, 10 cycle	
7	Vibration test(non-operating)	Ta = 25° C, 60%RH, 1.5G, 10~500Hz, Sine X,Y,Z / Sweep rate : 1 hour	Note 1
8	Shock test(non-operating)	Ta = 25°C, 60%RH, 220G, Half Sine Wave 2msec $\pm X$, $\pm Y$, $\pm Z$ Once for each direction	Note 1
9	Electro-static discharge test (operating)	Air : 150 pF, 330 Ω , ±8 KV Contact : 150 pF, 330 Ω , ±4 KV Ta = 25°C , 60%RH,	Note 2

<Table 10. Reliability test>

Note1:Ts is the temperature of panel's surface.

Note2: Ta is the ambient temperature of sample.

Note3: Before cosmetic and function test, the product must have enough recovery timeat least 2 hours at room temperature.

Note 4: in the standard condition, there shall be no practical problem that may aftect the display function. After the reliability test, the product only guarantees operation, but don'guarantee all of the cosmetic specification.



9.0 HANDLING & CAUTIONS

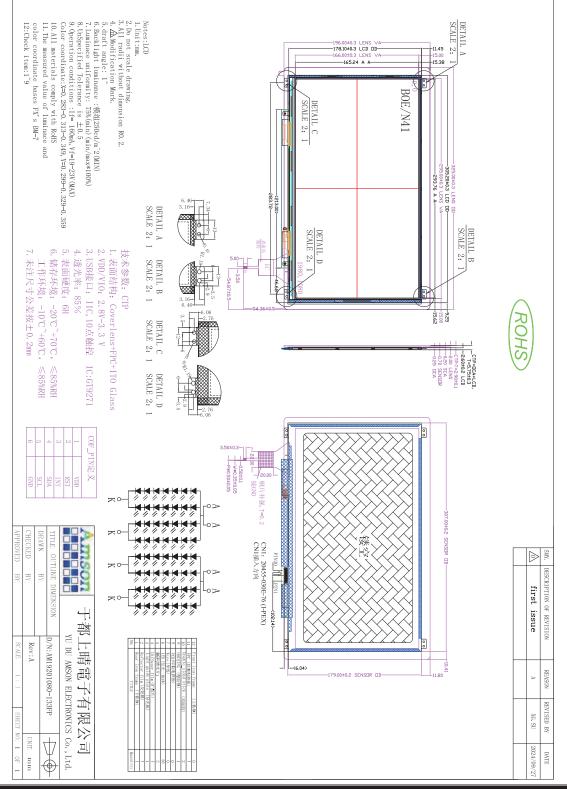
- (1) Cautions when taking out the module
 - Pick the pouch only, when taking out module from a shipping package.
- (2) Cautions for handling the module
 - As the electrostatic discharges may break the LCD module, handle the LCD module with care. Peel a protection sheet off from the LCD panel surface as slowly as possible.
 - As the LCD panel and back light element are made from fragile glass material, impulse and pressure to the LCD module should be avoided.
 - As the surface of the polarizer is very soft and easily scratched, use a soft dry cloth without chemicals for cleaning.
 - Do not pull the interface connector in or out while the LCD module is operating.
 - Put the module display side down on a flat horizontal plane.
 - Handle connectors and cables with care.
- (3) Cautions for the operation
 - When the module is operating, do not lose CLK, ENAB signals. If any one of these signals is lost, the LCD panel would be damaged.
 - Obey the supply voltage sequence. If wrong sequence is applied, the module would be damaged.
- (4) Cautions for the atmosphere
 - Dew drop atmosphere should be avoided.
 - Do not store and/or operate the LCD module in a high temperature and/or humidity atmosphere. Storage in an electro-conductive polymer packing pouch and under relatively low temperature atmosphere is recommended.

(5) Cautions for the module characteristics

- Do not apply fixed pattern data signal to the LCD module at product aging.
- Applying fixed pattern for a long time may cause image sticking.
- (6) Other cautions
 - Do not disassemble and/or re-assemble LCD module.
 - Do not re-adjust variable resistor or switch etc.
 - When returning the module for repair or etc., Please pack the module not to be broken. We recommend to use the original shipping packages.



10. Total Solution Outline Dimension



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11 EDID Table

Address (HEX)	Function	Hex	Dec	crc	Input values.	Notes
00		00	0		0	
01	Ī	FF	255		255	
02	l í	FF	255		255	
03	l [FF	255		255	
04	Header	FF	255		255	EDID Header
05	l l	FF	255		255	
06	l l	FF	255		255	
07		00	0		0	
08	ID Manufacturer	09	9		0.05	10 005
09	Name	E5	229		BOE	ID = BOE
0A		1F	31		0100	10 0100
0B	ID Product Code	08	8		3108	ID = 3108
0C		00	0		0	
0D	32-bit serial No.	00	0		0	
0E	32-bit serial No.	00	0		0	
0F	Ī	00	0		0	
10	Week of manufacture	21	33		25	
11	Year of Manufacture	1C	28		2022	Manufactured in 2022
12	EDID Structure Ver.	01	1		1	EDID Ver 1.0
13	EDID revision #	04	4		4	EDID Rev. 0.4
14	Video input definition	95	149		-	Refer to right table
15	Max H image size	1D	29		29	29.376 cm (Approx)
16	Max V image size	11	17		17	16.524 cm (Approx)
17	Display Gamma	78	120		2.2	Gamma curve = 2.2
18	Feature support	03	3		-	Refer to right table
19	Red/Green low bits	E7	231		-	Red / Green Low Bits
1A	Blue/White low bits	B0	176		-	Blue / White Low Bits
1B	Red x high bits	95	149	604	0.651	Red (x) = 10010101 (0.651)
1C	Red y high bits	5C	92	358	0.345	Red (y) = 01011100 (0.345)
1D	Green x high bits	59	89	338	0.331	Green(x) = 01011001(0.331)
1E	Green y high bits	94	148	568	0.612	Green (y) = 10010100 (0.612)
1F	Blue x high bits	29	41	157	0.151	Blue (x) = 00101001 (0.151)
20	BLue y high bits	22	34	122	0.057	Blue (y) = 00100010 (0.057)
21	White x high bits	50	80	321	0.303	White $(x) = 01010000 (0.303)$
22	White y high bits	54	84	337	0.325	White $(y) = 01010100 (0.325)$
23	Established timing 1	00	0		-	
24	Established timing 2	00	0		-	Refer to right table
25	Established timing 3	00	0		-	-



26	Standard timing #1	01	1		Not Used
27	Standard tinning π i	01	1		Not Used
28	Standard timing #2	01	1		Not Used
29		01	1		1101 0300
2A	Standard timing #3	01	1		Not Used
2B		01	1		1101 0300
2C	Standard timing #4	01	1		Not Used
2D		01	1		1107 0000
2E	Standard timing #5	01	1		Not Used
2F	otandara tirinig #0	01	1		1101 0000
30	Standard timing #6	01	1		Not Used
31	otandara tirinig #o	01	1		1101 0000
32	Standard timing #7	01	1		Not Used
33		01	1		
34	Standard timing #8	01	1		Not Used
35	otandara tirinig #o	01	1		1101 0000
36		C1	193	 147.8	147.8MHz Main clock
37		37	55		
38		80	128	 1920	Hor Active = 1920
39		CC	204	280	Hor Blanking = 280
ЗA		71	113	-	4 bits of Hor. Active + 4 bits of Hor. Blanking
3B		38	56	1080	Ver Active = 1080
3C		28	40	40	Ver Blanking = 40
3D	Detailed	40	64	-	4 bits of Ver. Active + 4 bits of Ver. Blanking
3E	timing/monitor	30	48	48	Hor Sync Offset = 48
3F	descriptor #1	20	32	32	H Sync Pulse Width = 32
40		36	54	3	V sync Offset = 3 line
41		00	0	6	V Sync Pulse width : 6 line
42		26	38	294	Horizontal Image Size = 294 mm (Low 8 bits)
43		A5	165	165	Vertical Image Size = 165 mm (Low 8 bits)
44		10	16	-	4 bits of Hor Image Size + 4 bits of Ver Image Size
45		00	0	0	Hor Border (pixels)
46		00	0	0	Vertical Border (Lines)
47		1A	26	-	Refer to right table



	2B	43		
	39	57	147.8	147.8MHz Main clock
	80	128	1920	Hor Active = 1920
	18	24	280	Hor Blanking = 280
	71	113	-	4 bits of Hor. Active + 4 bits of Hor. Blanking
	38	56	1080	Ver Active = 1080
	28	40	40	Ver Blanking = 40
	40	64	-	4 bits of Ver. Active + 4 bits of Ver. Blanking
Detailed timing/monitor	30	48	48	Hor Sync Offset = 48
descriptor #2	20	32	32	H Sync Pulse Width = 32
	36	54	3	V sync Offset = 3 line
	00	0	6	V Sync Pulse width : 6 line
	26	38	294	Horizontal Image Size = 294 mm (Low 8 bits)
	A5	165	165	Vertical Image Size = 165 mm (Low 8 bits)
	10	16	-	4 bits of Hor Image Size + 4 bits of Ver Image Size
	00	0	0	Hor Border (pixels)
	00	0	0	Vertical Border (Lines)
	1A	26	-	Refer to right above table
	00	0		
	00	0		
	00	0		
	00	0		
	00	0		
	00	0		
	00	0		
	00	0		Nvidia nvDPS
Detailed timing/monitor	00	0		(Refer the tab of nvDPS)
descriptor #3	00	0		Lowest refresh rate that does not cause any visual/optical
	00	0		side effect
	00	0		side effect
	00	0		
	00	0		1
	00	0		
	00	0		
	00	0]
	00	0		



Ta=25+/-2°C

3.0 ELECTRICAL SPECIFICATIONS

3.2 Back-light Unit

< Table 3.2 LED Driving guideline specifications >

	Parameter	Min.	Тур.	Max.	Unit	Remarks			
Power supply LED Driver	Power supply voltage for LED Driver		5	12	21	V			
Power supply Back light	Power supply Current for Back light				-	21	-	V	
Power supply Current for Back light		I _{BLU}	-	160	-	mA	背光灯串: 8并7 串		
Power supply light	Power supply for Back light		-	3.95	-	W	LED Power Consu mption follow cust omerrequirements		
EN Control	Backlight on	V _{ENH}	1.6	-	BL_P WR	V	EN logic high v oltage		
Level	Backlight off	V _{ENL}	0	-	0.8	V	EN logic low vol tage		
PWM Control	PWM High Level	V _{PML}	1.6	-	BL_P WR	V			
Level	PWM Low Level	V _{PML}	0	-	0.8	V			
PWM Control Frequency		F _{PWM}	0.2	-	20	KHz			
Duty Ratio		-	25	-	100	%			

Notes : 1. Calculator Value for reference $I_{BLU} \times V_{BLU} = P_{BL_{PWR}}$ *85%

2. The LED Life-time define as the estimated time to 50% degradation of initial luminous under the condition of the ambient temperature of 25°C.